

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Assaf Natanzon</td> <td>08/29/2012</td> </tr> <tr> <td>Saar Cohen</td> <td>08/29/2012</td> </tr> <tr> <td>Jehuda Shemer</td> <td>08/30/2012</td> </tr> </tbody> </table>		Name	Execution Date	Assaf Natanzon	08/29/2012	Saar Cohen	08/29/2012	Jehuda Shemer	08/30/2012
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<table border="1"> <tr> <td>Name:</td> <td>EMC International Company</td> </tr> <tr> <td>Street Address:</td> <td>2 Church Street</td> </tr> <tr> <td>City:</td> <td>Hamilton</td> </tr> <tr> <td>State/Country:</td> <td>BERMUDA</td> </tr> </table>		Name:	EMC International Company	Street Address:	2 Church Street	City:	Hamilton	State/Country:	BERMUDA
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PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13599296</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13599296				
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CORRESPONDENCE DATA									
Fax Number: Phone: 508-435-1000 Email: Docketing@emc.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i> Correspondent Name: EMC CORPORATION OFFICE OF THE GENERAL CO Address Line 1: 176 SOUTH STREET Address Line 2: Joseph D'Angelo Address Line 4: HOPKINTON, MASSACHUSETTS 01748									
ATTORNEY DOCKET NUMBER:	EMC-12-135CIP5								
NAME OF SUBMITTER:	Joseph D'Angelo								
Total Attachments: 5 source=EMC-12-135CIP5_Assignment_IsraeltoEIC#page1.tif source=EMC-12-135CIP5_Assignment_IsraeltoEIC#page2.tif source=EMC-12-135CIP5_Assignment_IsraeltoEIC#page3.tif source=EMC-12-135CIP5_Assignment_IsraeltoEIC#page4.tif source=EMC-12-135CIP5_Assignment_IsraeltoEIC#page5.tif									

CH \$40.00 13599296

ASSIGNMENT

WHEREAS, we, Assaf Natanzon, Saar Cohen and Jehuda Shemer, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled *SNAPSHOT REPLICATION* (Application), the specification of which:

☒ is being executed on even date herewith and is about to be filed in the United States Patent Office;

☐ was filed on _____ as U.S. Application No. _____;

☐ was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC International Company (hereinafter "ASSIGNEE"), an unlimited private company organized under the laws of Ireland, with its principal place of activities at 2 Church Street, Hamilton, Bermuda, desires to acquire an interest therein in accordance with agreements duly entered into among EMC International Company, EMC Israel Development Center Ltd. and us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution,

reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND, we hereby authorize our attorneys, EMC Corporation, to insert here in parenthesis (13/599,296 filed on August 30, 2012) the application number and filing date of said Application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 29/8/2012 _____
Inventor's Signature

Print full name of inventor Assaf Natanzon
Residence Levanon 95, Tel Aviv, Israel 69395
Citizenship Israel
Mailing Address Same as above

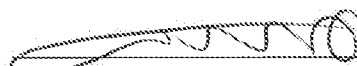
I, Avi Natan (name of first witness), whose residential address is
Haratim St Even Yehuda
was personally present and did see Assaf Natanzon (name of
person signing the assignment), who is personally known to me, execute the above assignment.

[Signature] (signature of first witness)
Signed at Haratim (location of witness signature)
on this day, 20/8, 2012 (date of signature).

I, Simon Taib (name of second witness), whose residential address is
Motzlot Yam 16, Givatayim
was personally present and did see Assaf Natanzon (name of
person signing the assignment), who is personally known to me, execute the above assignment.

[Signature] (signature of second witness)
Signed at Haratim (location of witness signature)
on this day, 20/8, 2012 (date of signature).

Date: 29/8/2012


Inventor's Signature

Print full name of inventor

Saar Cohen

Residence

POB 162, Mishmeret, Israel 40695

Citizenship

Israel

Mailing Address

Same as above

I, Avi Hufat (name of first witness), whose residential address is
Haratun St Ezer Yehuda
was personally present and did see Saar Cohen (name of
person signing the assignment), who is personally known to me, execute the above assignment.


(signature of first witness)

Signed at Herzlia (location of witness signature)

on this day, 30/8, 2012 (date of signature).

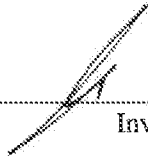
I, Simon Taib (name of second witness), whose residential address is
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(signature of second witness)

Signed at Herzlia (location of witness signature)

on this day, 30/8, 2012 (date of signature).

Date: 30/8/2012


Inventor's Signature

Print full name of inventor

Jehuda Shemer

Residence

Brenner 7 Street, Kfar Saba, Israel 44349


Citizenship

Israel


Mailing Address

Same as above

I, Avi Itzhak (name of first witness), whose residential address is
Haraton st Ezer Yehuda
was personally present and did see Jehuda Shemer (name of
person signing the assignment), who is personally known to me, execute the above assignment.


(signature of first witness)
Signed at Harzelia (location of witness signature)
on this day, 30/8, 20 12 (date of signature).

I, Simon Taib (name of second witness), whose residential address is
Metzilot Yam 16, Givatayim
was personally present and did see Jehuda Shemer (name of
person signing the assignment), who is personally known to me, execute the above assignment.


(signature of second witness)
Signed at Harzelia (location of witness signature)
on this day, 30/8, 20 12 (date of signature).